HS3AB - HS3MB

Taiwan Semiconductor

3A, 50V - 1000V High Efficient Surface Mount Rectifier

FEATURES

- Low power loss, high efficiency
- Low forward voltage drop
- Low profile package
- Fast switching for high efficiency
- Ideal for automated placement
- · Glass passivated junction chip
- Fast switching for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Monitor
- TV

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Part no. with suffix "H" means AEC-Q101 qualified
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.093 g (approximately)

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)										
PARAMETER	SYMBOL	HS	HS	HS	HS	HS	HS	HS	HS	UNIT
FARAMETER	STRIBUL	3AB	3BB	3DB	3FB	3GB	3JB	3KB	3MB	
Marking code on the device		HS	HS	HS	HS	HS	HS	HS	HS	
Warking code on the device		3AB	3BB	3DB	3FB	3GB	3JB	3KB	3MB	
Repetitive peak reverse voltage	V _{RRM}	50	100	200	300	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	210	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	300	400	600	800	1000	V
Forward current	I _{F(AV)}	3		Α						
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	100			A					
Junction temperature	TJ	- 55 to +150		°C						
Storage temperature	T _{STG}				- 55 to	o +150				°C

1

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _{F(AV)}	3	А		
V _{RRM}	50 - 1000	V		
I _{FSM}	100	А		
T _{J MAX}	150	°C		
Package	DO-214AA (SMB)			
Configuration	Signal Die			





DO-214AA (SMB)





THERMAL PERFORMANCE					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-ambient thermal resistance	R _{eJA}	60	°C/W		

PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
	HS3AB HS3BB	-		-	1.0	V V
	HS3DB	-				V
	HS3FB	-				V
Forward voltage per diode ⁽¹⁾	HS3GB	I _F = 3A,T _J = 25°C	V _F		1.3	V
	HS3JB	-				V
	HS3KB			-	1.7	V
	HS3MB	-				V
Reverse current @ rated V _R per di	odo ⁽²⁾	T _J =25°C	I _R	-	10	μA
Reverse current @ rated v _R per di	oue	T _J = 100°C	I _R	-	250	μA
	HS3AB		CJ	80	-	pF
	HS3BB				-	pF
	HS3DB				-	pF
lunction consoltance	HS3FB				-	pF
Junction capacitance	HS3GB	1 MHz, V _R =4V			-	pF
	HS3JB			50	-	pF
	HS3KB				-	pF
	HS3MB				-	pF
	HS3AB			-	50 75	ns
	HS3BB					ns
	HS3DB					ns
	HS3FB	I _F =0.5A , I _R =1.0A	t _{rr}			ns
Reverse recovery time	HS3GB	I _{RR} =0.25A				ns
	HS3JB			-		ns
	HS3KB					ns
	HS3MB					ns

Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms





ORDERING INFORMATION						
PART NO.	PART NO. SUFFIX	PACKING Code	PACKING CODE SUFFIX(*)	PACKAGE	PACKING	
		R5		SMB	850 / 7" Plastic reel	
HS3xB (Note 1)	Н	R4	G	SMB	3,000 / 13" Paper reel	
		M4		SMB	3,000 / 13" Plastic reel	

Note:

1. "x" defines voltage from 50V (HS3AB) to 1000V (HS3MB)

*: Optional available

EXAMPLE P/N					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
HS3ABHR5G	HS3AB	Н	R5	G	AEC-Q101 qualified Green compound



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

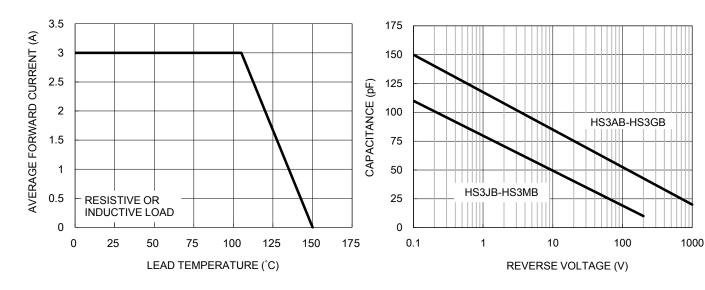
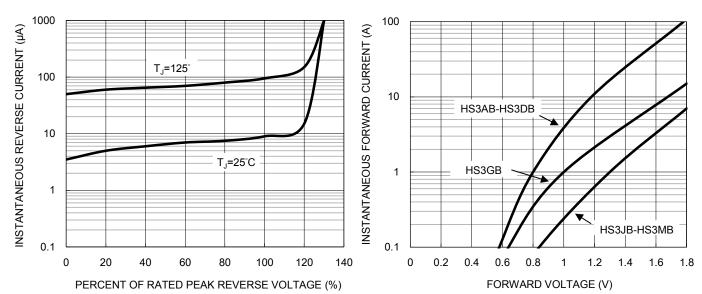


Fig1. Forward Current Derating Curve

Fig2. Typical Junction Capacitance

Fig3. Typical Reverse Characteristics

Fig4. Typical Forward Characteristics





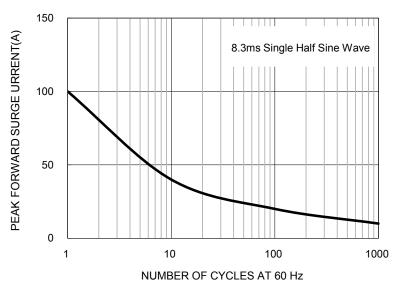
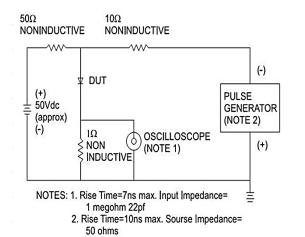
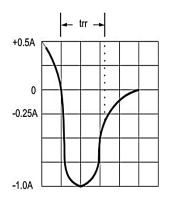


Fig5. Maximum Non-repetitive Forward Surge Current



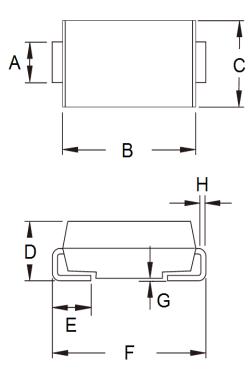






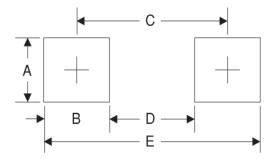
PACKAGE OUTLINE DIMENSIONS

DO-214AA (SMB)



DIM.	Unit (mm)		Unit (inch)		
Dilvi.	Min	Max	Min	Max	
А	1.95	2.20	0.077	0.087	
В	4.05	4.60	0.159	0.181	
С	3.30	3.95	0.130	0.156	
D	1.95	2.65	0.077	0.104	
E	0.75	1.60	0.030	0.063	
F	5.10	5.60	0.201	0.220	
G	0.05	0.20	0.002	0.008	
Н	0.15	0.31	0.006	0.012	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.3	0.091
В	2.5	0.098
С	4.3	0.169
D	1.8	0.071
E	6.8	0.268

MARKING DIAGRAM



P/N = Marking Code

- G = Green Compound
- YW = Date Code
- F = Factory Code



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